

TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

TC75S54F, TC75S54FU

Single Operational Amplifier

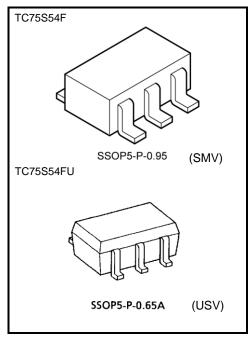
The TC75S54F/TC75S54FU is a CMOS single-operation amplifier which incorporates a phase compensation circuit. It is designed for use with a low-voltage, low-current power supply; this differentiates this device from conventional general-purpose bipolar op-amps.

Features

- Low-voltage operation : $V_{DD} = \pm 0.9 \text{ to } \pm 3.5 \text{ V or } 1.8 \text{ to } 7 \text{ V}$
- Low-current power supply : IDD (VDD = 3 V) = $100 \mu \text{A}$ (typ.)
- Built-in phase-compensated op-amp, obviating the need for any external device
- Ultra-compact package

Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Supply voltage	V _{DD} , V _{SS}	7	٧
Differential input voltage	DVIN	±7	V
Input voltage	VIN	V _{DD} to V _{SS}	V
Power dissipation	PD	200	mW
Operating temperature	T _{opr}	-40 to 85	°C
Storage temperature	T _{stg}	-55 to 125	°C



Weight

SSOP5-P-0.95 : 0.014 g (typ.) SSOP5-P-0.65A : 0.006 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

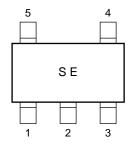
Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

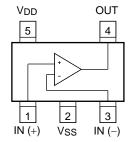
Start of commercial production 1995-01



Marking (top view)

Pin Connection (top view)





Electrical Characteristics

DC Characteristics (V_{DD} = 3.0 V, V_{SS} = GND, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	VIO	1	$R_S = 1 \text{ k}\Omega$	_	2	10	mV
Input offset current	lio	_	_	_	1	_	pА
Input bias current	lı	_	_	_	1	_	pА
Common mode input voltage	CMVIN	2	_	0.0	_	2.1	V
Voltage gain (open loop)	Gv	_	_	60	70	_	dB
Maximum output voltage	Voн	3	R _L ≥ 100 kΩ	2.9	_	_	V
	V _{OL}	4	R _L ≥ 100 kΩ	_	_	0.1	
Common mode input signal rejection ratio	CMRR	2	V _{IN} = 0.0 to 2.1 V	60	70	_	dB
Supply voltage rejection ratio	SVRR	1	V _{DD} = 1.8 to 7.0 V	60	70	_	dB
Supply current	I _{DD}	5	_	_	100	200	μА
Source current	Isource	6	_	100	200	_	μА
Sink current	I _{sink}	7	_	200	700	_	μА

DC Characteristics (V_{DD} = 1.8 V, V_{SS} = GND, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Input offset voltage	V _{IO}	1	$R_S = 10 \text{ k}\Omega$	_	2	10	mV
Input offset current	IIO	_	_	_	1	_	pА
Input bias current	lı	_	_	_	1	_	pА
Common mode input voltage	CMVIN	2	_	0.2	_	0.9	V
Voltage gain (open loop)	GV	_	_	60	70	_	dB
Maximum output voltage	Voh	3	R _L ≥ 100 kΩ	1.7	_	_	.,
	V _{OL}	4	R _L ≥ 100 kΩ	_	_	0.1	V
Supply current	IDD	5	_	_	80	160	μΑ
Source current	Isource	6	_	80	160	_	μΑ
Sink current	I _{sink}	7	_	200	600	_	μА



AC Characteristics (V_{DD} = 3.0 V, V_{SS} = GND, Ta = 25°C)

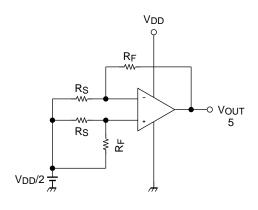
Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Slew rate	SR	_	_	_	0.7	_	V/μs
Unity gain cross frequency	fΤ				0.9	_	MHz

AC Characteristics (V_{DD} = 1.8 V, V_{SS} = GND, Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Тур.	Max	Unit
Slew rate	SR	_	_	_	0.6	_	V/μs
Unity gain cross frequency	f⊤	_	_	_	0.8	_	MHz

Test Circuit

1. SVRR, Vio



SVRR

For each of the two V_{DD} values, measure the V_{OUT} value, as indicated below, and calculate the value of SVRR using the equation shown.

When $V_{DD} = 1.8 \text{ V}$, $V_{DD} = V_{DD}1$ and $V_{OUT} = V_{OUT}1$ When $V_{DD} = 7.0 \text{ V}$, $V_{DD} = V_{DD}2$ and $V_{OUT} = V_{OUT}2$

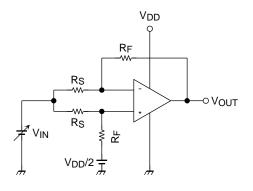
$$SVRR = 20 log \left(\frac{|V_{OUT}1 - V_{OUT}2|}{|V_{DD}1 - V_{DD}2|} \times \frac{R_S}{R_F + R_S} \right)$$

Vio

Measure the value of $V_{\mbox{\scriptsize OUT}}$ and calculate the value of $V_{\mbox{\scriptsize IO}}$ using the following equation.

$$V_{IO} = \left(V_{OUT} - \frac{V_{DD}}{2}\right) \times \frac{R_S}{R_F + R_S}$$

2. CMRR, CMVIN



CMRR

Measure the $V_{\mbox{OUT}}$ value, as indicated below, and calculate the value of the CMRR using the equation shown.

When $V_{IN} = 0.0 \text{ V}$, $V_{IN} = V_{IN}1$ and $V_{OUT} = V_{OUT}1$ When $V_{IN} = 2.1 \text{ V}$, $V_{IN} = V_{IN}2$ and $V_{OUT} = V_{OUT}2$

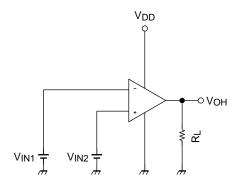
$$CMRR = 20 \log \left(\left| \frac{V_{OUT}1 - V_{OUT}2}{V_{IN}1 - V_{IN}2} \right| \times \frac{R_S}{R_F + R_S} \right)$$

CMV_{IN}

Input range within which the CMRR specification guarantees $V_{\mbox{OUT}}$ value (as varied by the $V_{\mbox{IN}}$ value).



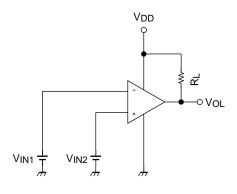
3. Vон



VOH

$$V_{IN1} = \frac{V_{DD}}{2} - 0.05 \text{ V}$$
$$V_{IN2} = \frac{V_{DD}}{2} + 0.05 \text{ V}$$

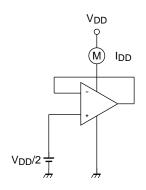
4. Vol



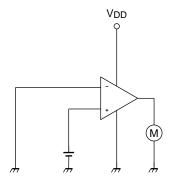
• Voi

$$V_{IN1} = \frac{V_{DD}}{2} + 0.05 \text{ V}$$
$$V_{IN2} = \frac{V_{DD}}{2} - 0.05 \text{ V}$$

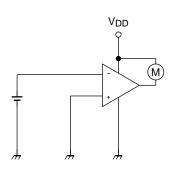
5. IDD



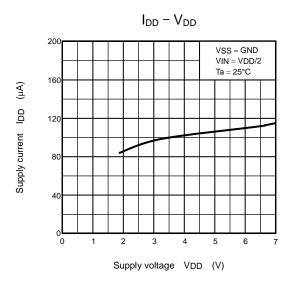
6. Isource

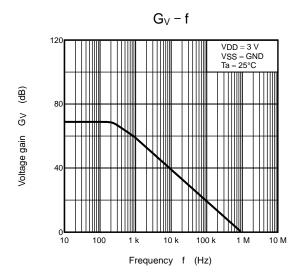


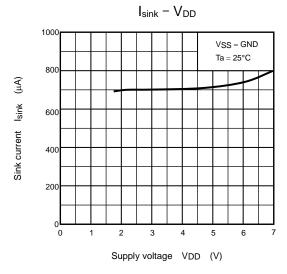
7. Isink

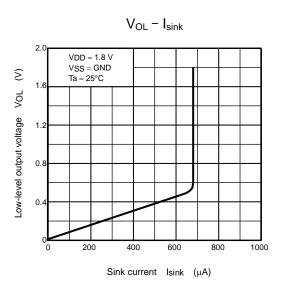


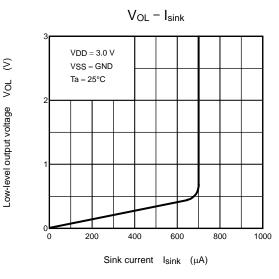


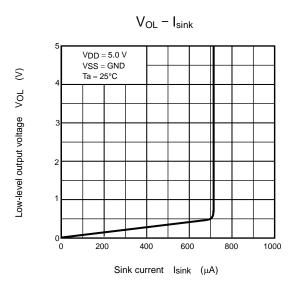






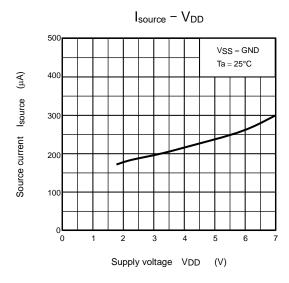


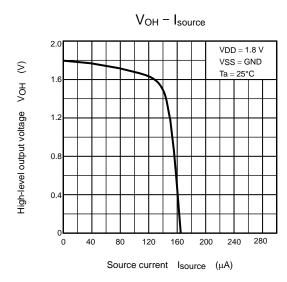


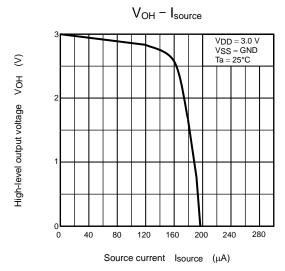


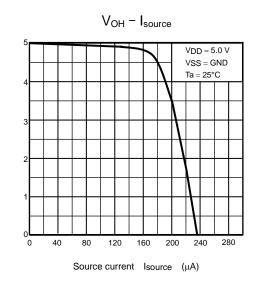
The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

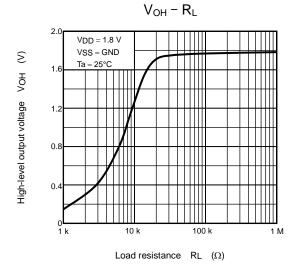


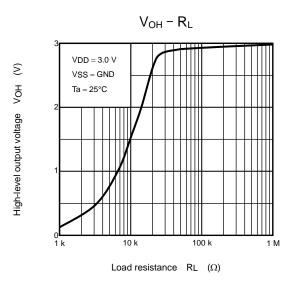










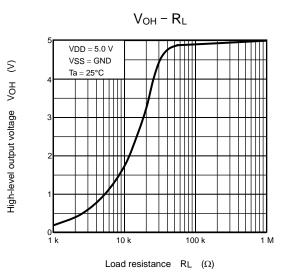


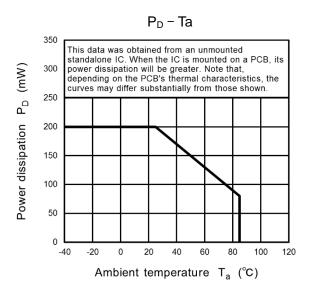
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High-level output voltage VOH





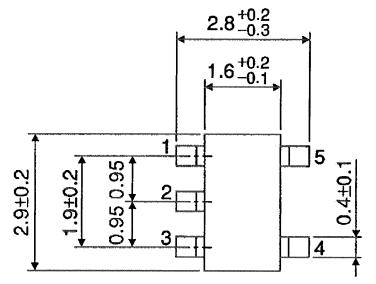


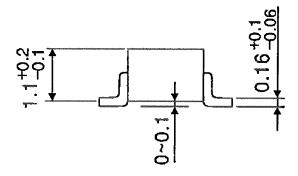
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Package Dimensions

SSOP5-P-0.95 Unit: mm



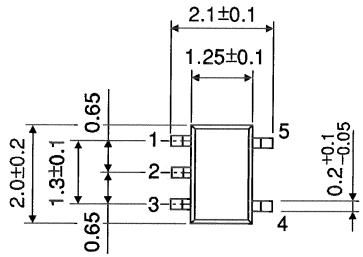


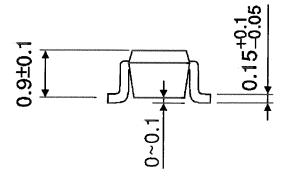
Weight: 0.014 g (typ.)



Package Dimensions

SSOP5-P-0.65A Unit: mm





Weight: 0.006 g (typ.)



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